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Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

On

August 30, 2005

TOWNSEND and TOWNSEND and CREW LLP

By:

Eleanor J. Taylor

PATENT

Attorney Docket No.: 021653-003100US

Client Ref. No.: I-02-144

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Yuan-Heng Fan

Application No.: 10/773,800

Filed: February 6, 2004

For: METHOD AND DEVICE FOR
MANUFACTURING BONDING PADS
FOR CHIP SCALE PACKAGING

Customer No.: 20350

Confirmation No. 8468

Examiner: Granvill D. Lee

Technology Center/Art Unit: 2891

RESPONSE TO OFFICE ACTION
Mailed June 3, 2005

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Office Action mailed June 3, 2005, please enter the following amendments and remarks:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Amendments to the Drawings begin on page 5 of this paper and include both an attached replacement sheet and an annotated sheet showing changes.

Remarks/Arguments begin on page 6 of this paper.

An **Appendix** including amended drawing figures is attached following page 9 of this paper.